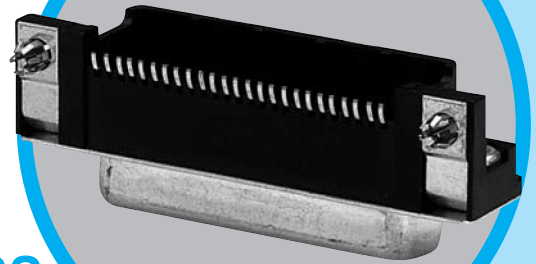


SM2

D-Sub connectors - Stamped and Formed Contacts

SURFACE MOUNT CONNECTORS



CHARACTERISTICS

Specifications

- Connectors according to MIL C24308 - NFC 93425-HE5

Materials and Platings	
Shells	Steel with tin plating
Insulator	High temperature (peak at 260°C) glass-filled thermoplastic, UL 94V-0
Socket contact	Stamped and formed brass, selected gold in mating area; 2.54µm (100µ") min. tin on termination area, with entire contact under-plated 1.27µm (50µ") min. nickel
Rear insert	Brass, 3µm up to 5µm (118µ" up to 197µ") tinned over nickel 2µm up to 3 µm (78µ" to 118µ")
Boardlock	Tin plating 4µm up to 6µm (157µ" up to 236µ") over nickel 2µm up to 3µm (78µ" up to 118µ"), insertion force: Low Insertion Force = LIF (bronze) Zero Insertion Force = ZeFo (bronze)
Screwlock	Brass, 6µm up to 10µm (236µ" up to 394µ") tinned over nickel 2µm up to 3µm (78µ" up to 118µ")
Grounding	Grounding strap: brass, 4µm up to 6µm tin plating over nickel 2µm up to 3µm (78µ" up to 118µ")

Electrical Data	
Current rating	3A
Voltage rating	300V AC/rms 50Hz
Withstanding voltage	1000V AC/rms 50Hz for one minute
Insulation resistance	5000MΩ
Contact resistance	10mΩ max

Climatic Data	
Operating temperature	85°C, peak at 105°C
Damp heat	56 days (40°C - 95% HR)

Mechanical Data		
Single contact insertion force	1.2N < F < 2.5N	
Single contact withdrawal force	0.4N min	
LIF boardlock	8N max per connector	
Coplanarity of contacts	0.2mm (.008”) max	
Mating and unmating force		
Unit: N		
No. of Cts	Mate (max)	Unmate (min)
9 (size E)	30	3.5
15 (size A)	50	4.5
25 (size B)	83	8.0

DESCRIPTION

Amphenol SMT D-Sub is offered in right angle, receptacle with brackets, as an industry standard for I / O connections.

Boardlock features:

- LIF (Low Insertion Force) boardlock especially designed to be fully compatible with pick and place machine.
- ZeFo (Zero Force Insertion) boardlock has been designed so that once placed and expanded, secures a safe locking.

*Designed for
Pick and Place
SMT process*

APPLICATIONS

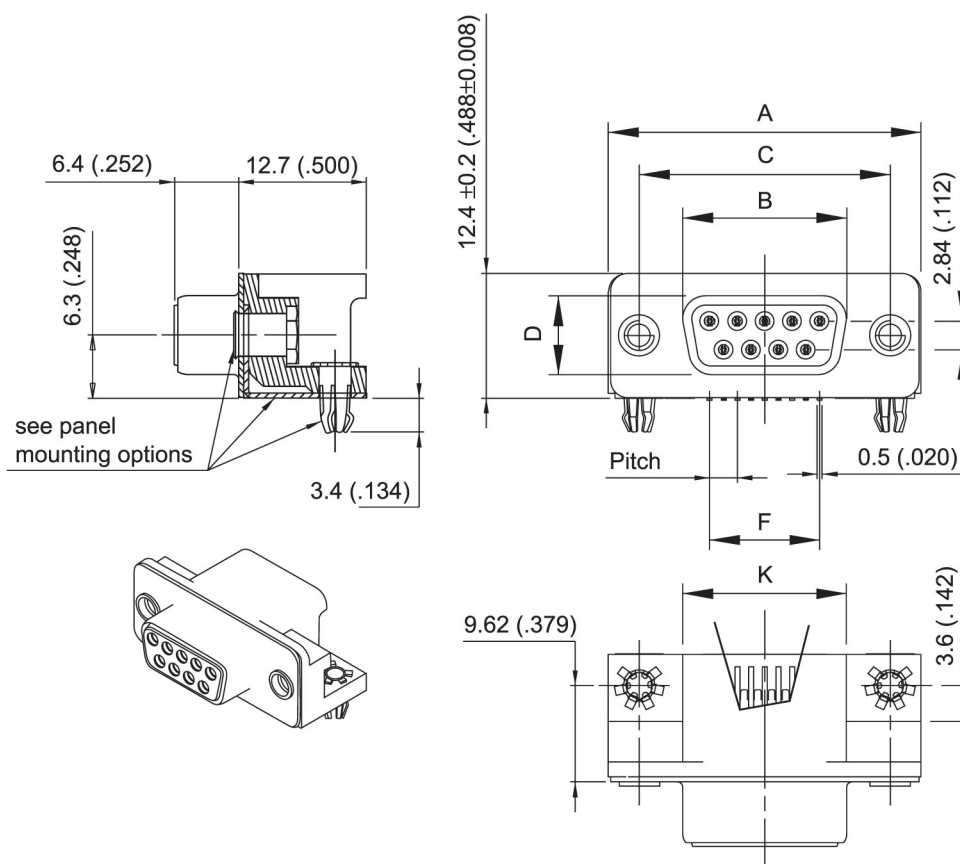
- Industrial
- Telecom
- Any industry standard I / O connections



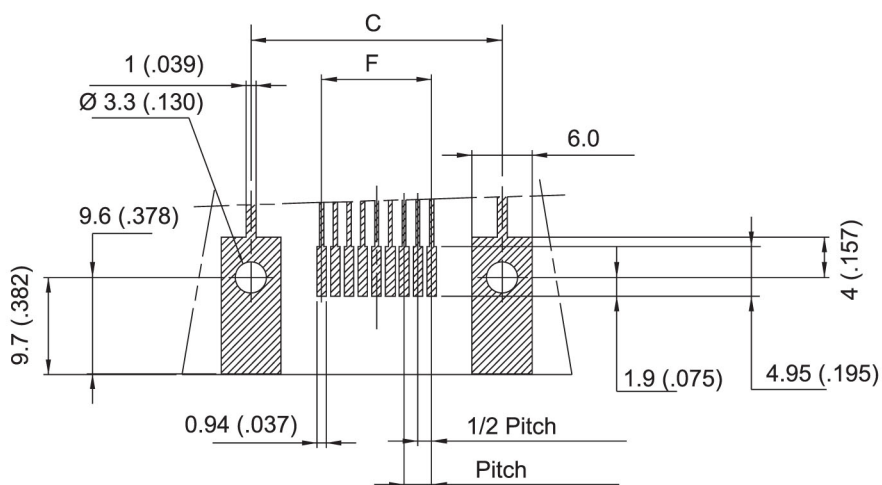
Amphenol

SM2 / E2

Shell Size Dimensions



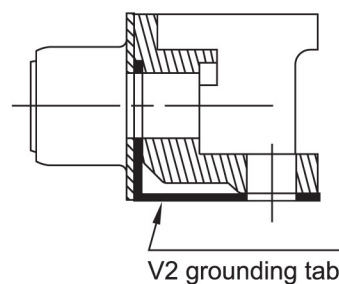
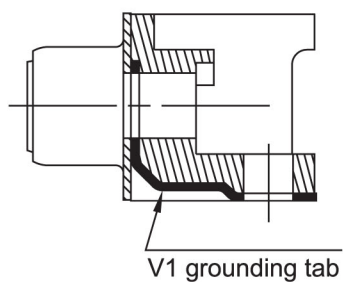
PCB LAYOUT



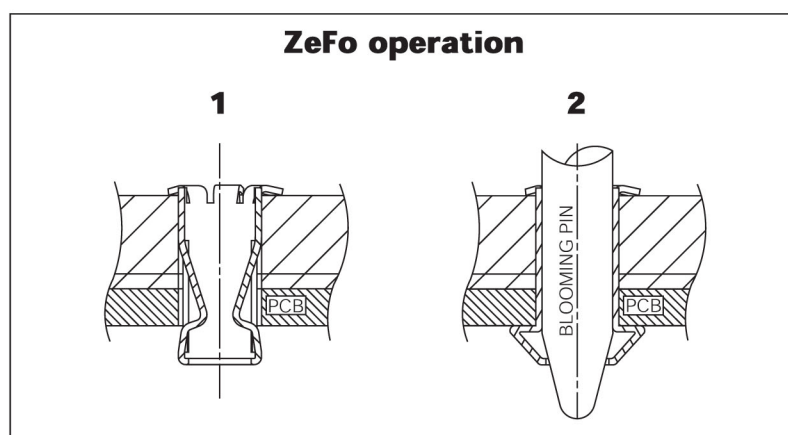
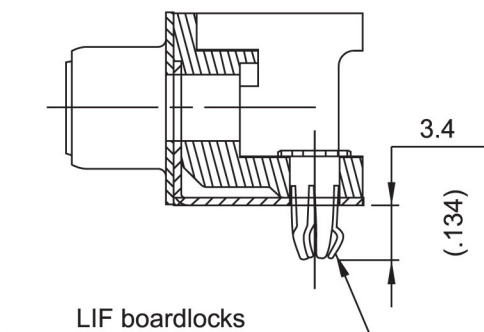
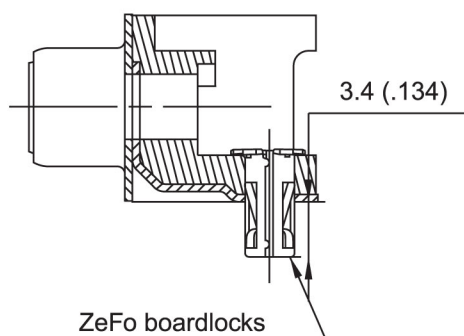
SHELL SIZE	mm (inch)						
	A +0.05 (.002) -0.1 (.004)	B 0 -0.2 (.008)	C ± 0.1 (.004)	D 0 -0.25 (.01)	PITCH	F	K
E	31.15 (1.226)	16.4 (.645)	25 (.984)	8.03 (.316)	2.74 (.1078)	10.97 (.432)	16.3 (.642)
A	39.4 (1.551)	24.8 (.976)	33.3 (1.311)	8.03 (.316)	2.74 (.1078)	19.2 (.756)	24.6 (.968)
B	53.3 (2.098)	38.5 (1.515)	47 (1.850)	8.03 (.316)	2.76 (.1086)	33.12 (1.304)	38.3 (1.508)

Panel mounting option

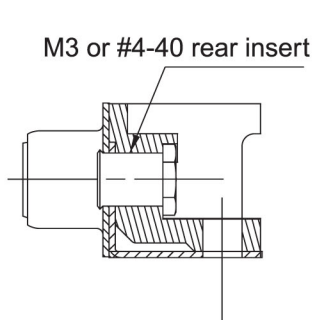
GROUNDING TABS:



BOARDLOCKS:

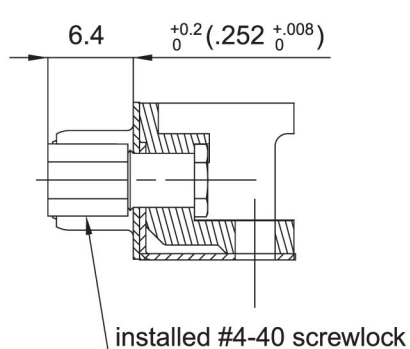


FLANGES ACCESSORIES:



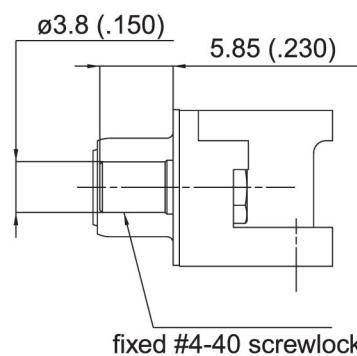
Threaded Rear

1/2



Installed Front Female

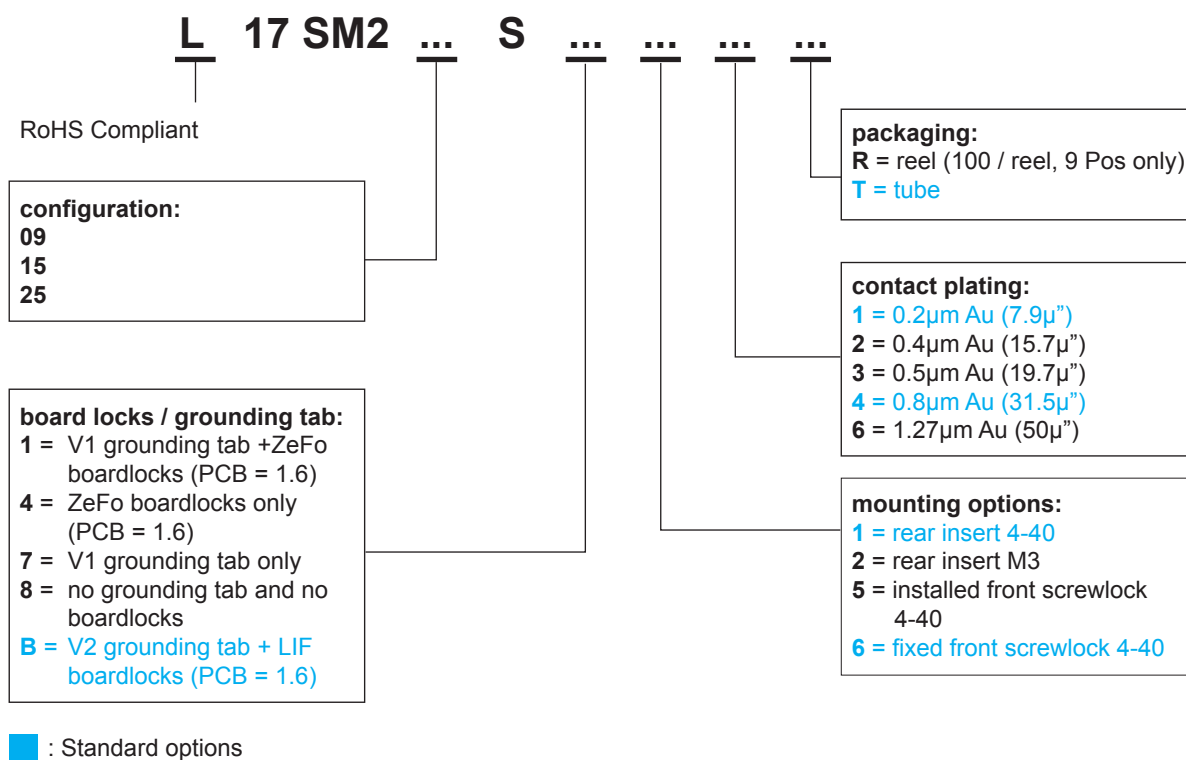
5



Fixed Front Female

6

How to order



For special request, please consult factory

Memo

This image shows a single sheet of white paper with horizontal blue ruling lines. The lines are evenly spaced and run across the width of the page. There are no margins, text, or other markings on the paper.

Do not hesitate to contact us for further information

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Amphenol

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